

<b>Notice of References Cited</b>	Application/Control No. 09/467,253	Applicant(s)/Patent Under Reexamination CHITTIPEDDI ET AL.	
	Examiner Michelle Estrada	Art Unit 2823	Page 1 of 1

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	C	US-5,045,151	09-1991	Edell, David J.	252/79.3
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**NON-PATENT DOCUMENTS**

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	U	Harper, Charles A., "Electronic Packaging and Interconnection Handbook", 1991 by McGraw-Hill, page 10.47.
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\*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)  
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